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WSE

9/30/03

UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:
Chan, *et al.*

Serial No.: 09/757,364

Filed: January 8, 2001

For: Method for Joining Large Substrates

Examiner: John T. Harlan

Art Unit: 1733

Att'y Dkt.: 02EK-104742

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(37 C.F.R. § 1.8A)**

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9-17-03
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Jordan Wilson
Signature

AMENDMENT "B"

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the non-final Office Action mailed March 20, 2003, please amend the
above-identified application as follows:

Amendments to the Specification begin on page 2 of this paper;

Amendments to the Claims are reflected in the **Listing of Claims** which begins
on page 3 of this paper; and

Remarks begin on page 7 of this paper.

A Petition for Extension of Time and the requisite fee for filing a response within the
third month are enclosed. A DECLARATION OF ALBERT W. CHAN UNDER 37 C.F.R.
§1.131 is attached hereto. Reexamination and reconsideration of the application in light of these
amendments and remarks are respectfully requested.